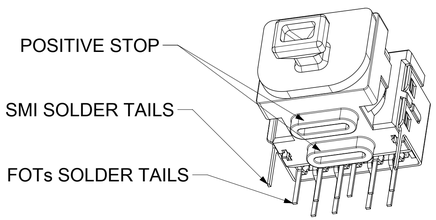
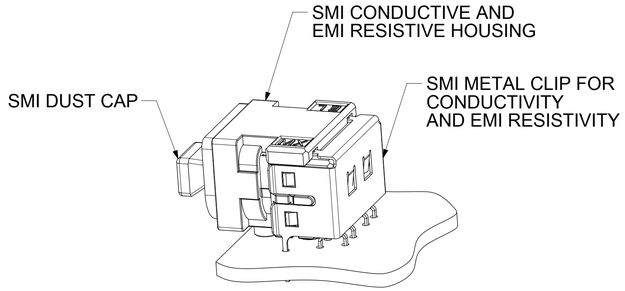
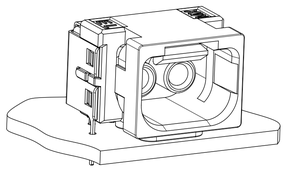
| SMI TRANSCEIVER ASSEMBLY P/N | FOT's TYPE | FOT CODE |
|---|---|---|
| 1061083100 | ETHERNET 10/100 | EL |
| 1061084100 | INDUSTRIAL DATA LINK | ID |

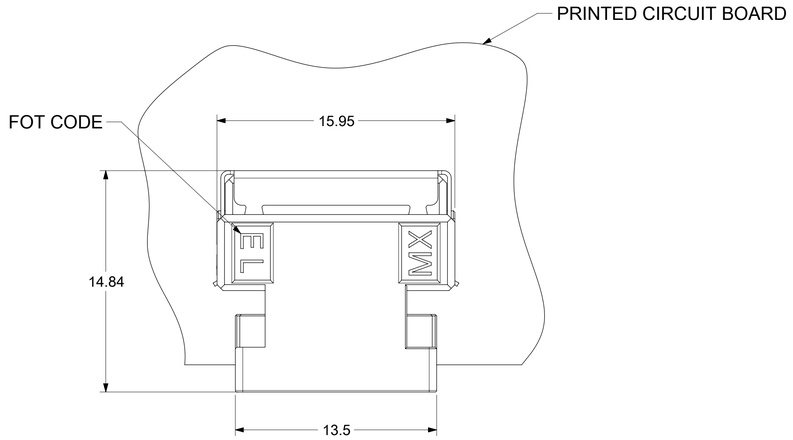


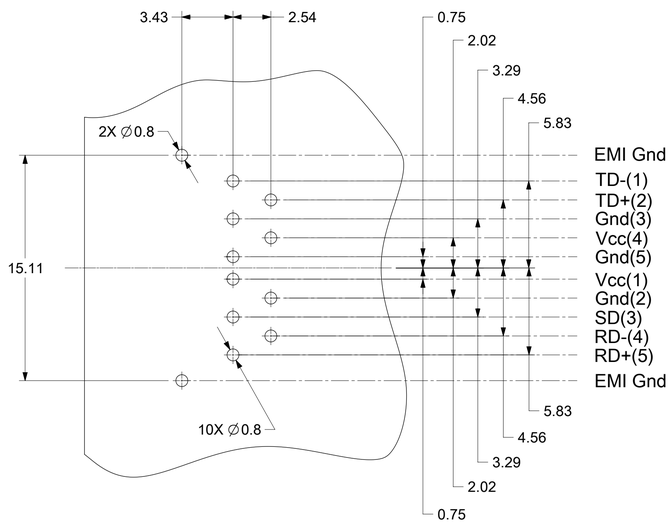

ISOMETRIC VIEWS
SCALE 3:1



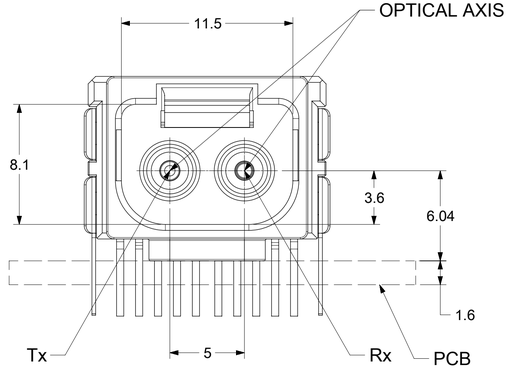
DUST CAP
IS NOT SHOWN



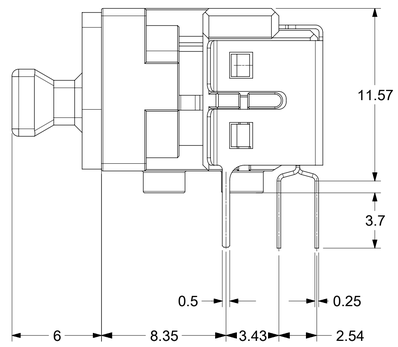

DUST CAP
IS NOT SHOWN

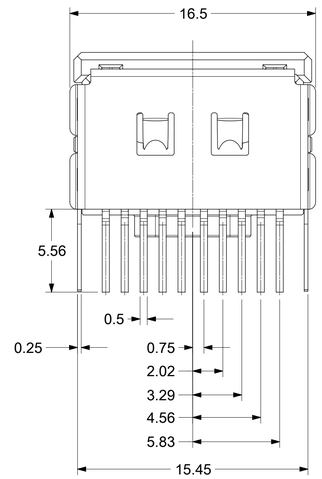



RECOMMENDED PCB LAYOUT
DIMENSIONS TOLERANCE: ±0.1mm




SMI TRANSCEIVER ASSEMBLY
MOUNTED ON THE PCB
DUST CAP IS NOT SHOWN




NOTES:

1. ALL DIMENSIONS ARE FOR REFERENCE ONLY EXCEPT FOR RECOMMENDED PCB LAYOUT.

2. SMI TH TRANSCEIVERS MAY BE SOLDERED TO MAX 260°, MAX 10s, ONE TIME ONLY,
   AT LEAST 2.20mm AWAY FROM LEAD ROOT.
   RE-FLOW OVEN SOLDERING IS NOT APPROVED AT THIS TIME.
   FOR MORE DETAILS SEE DATASHEET.

| RELEASE STATUS | P1 | RELEASE DATE | 23.08.2016 | 14:39:45 |
|---|---|---|---|---|

QUALITY SYMBOLS: A = 0, E = 0, D = 0, ▼ = 0, C = 0, ☒ = 0, ■ = 0, C = 0

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EC NO: 107440 | 2016/07/12
DRWN: SBOJANIC | 2016/08/23
CHK'D:
APPR: IGUMIN
REV: D

GENERAL TOLERANCES (UNLESS SPECIFIED)

| | |
|---|---|
| ANGULAR TOL ± | ° |
| 4 PLACES | ± |
| 3 PLACES | ± |
| 2 PLACES | ± |
| 1 PLACE | ± |
| 0 PLACES | ± |

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION UNITS: MM | SCALE: 5:1
DRWN BY: SBOJANIC | DATE: 2016/07/12
CHK'D BY: | DATE:
APPR BY: IGUMIN | DATE: 2016/08/23
DRAWING SIZE: D | THIRD ANGLE PROJECTION

molex®

SMI TRANSCEIVER ASSEMBLY TH SOLDERING

PRODUCT CUSTOMER DRAWING

| SERIES | MATERIAL NUMBER | CUSTOMER |
|---|---|---|
| 106108 | SEE TABLE | |

| DOCUMENT NUMBER | DOC TYPE | DOC PART | SHEET NUMBER |
|---|---|---|---|
| 1061083100 | PSD | 000 | 1 OF 1 |